

IDS - 11/10/2005

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

**Title of
Invention**Elimination of RDL Using Tape Base Flip Chip on Flex for Die
Stacking

Application Number : 10/050507
Confirmation Number: 7687
First Named Applicant: Teck Lee
Attorney Docket Number: MTI-31607
Art Unit: 2813
Examiner: Jack SJ Chen
Search string: (6308525 or 5468995 or 6610559).pn

**US Patent Documents****Note: Applicant is not required to submit a paper copy of cited US Patent Documents**

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	6308525	2001-03-27	Imasu et al.		361	783
DAZ	2	5468995	1995-11-21	Higgins III		257	697
DAZ	3	6610559	2003-08-26	Wang et al.		438	108


Signature

Examiner Name	Date
/David Zarneke/	05/22/2006

IDS - 01/03/2006 **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

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Stylesheet Version v18.0

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PTO/SB/08a (08-03)

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number	10050507
	Filing Date	2002-01-16
	First Named Inventor	Teck Kheng Lee
	Art Unit	2891
	Examiner Name	David A. Zameke
Attorney Docket Number		MTI-31607

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DAZ	1	5/68109		1998-06-16	Gulick et al.		
	2	6285081	B1	2001-09-04	Jackson		
	3	6037665		2000-03-14	Miyazaki		
	4	6791195	B2	2004-09-14	Urushima		
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	1	20020127769	A1	2002-09-12	Ma et al.		
DAZ	2	20030012930	A1	2003-01-16	Brousseau, III		

/David Zameke/

05/19/2006

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init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	4415403	1983-11-15	Bakewell		216	27
DAZ	2	6847105	2005-01-25	Koopmans		257	686
Signature							
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